

DF051

Fast Recovery Diode

DS4147-7 July 2014 (LN31795)

APPLICATIONS

- Induction Heating
- A.C. Motor Drives
- Inverters And Choppers
- Welding
- High Frequency Rectification
- **■** UPS

FEATURES

- Double side cooling
- High surge capability
- Low recovery charge

VOLTAGE RATINGS

Type Number	Repetitive Peak Reverse Voltage V _{RRM} V	Conditions
DF051 25	2500	$V_{RSM} = V_{RRM} + 100V$
DF051 24	2400	TIOM THUM
DF051 22	2200	
DF051 20	2000	

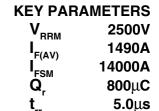
Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table, e.g.:

DF051 22

Note: Please use the complete part number when ordering and quote this number in any future correspondance relating to your order.



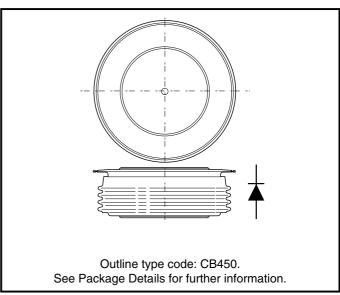


Fig. 1 Package outline



CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units				
Double Sid	Double Side Cooled							
I _{F(AV)}	Mean forward current	Half wave resistive load, T _{case} = 65°C	1490	А				
I _{F(RMS)}	RMS value	T _{case} = 65°C	2340	Α				
I _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	2160	Α				
Single Side Cooled (Anode side)								
I _{F(AV)}	Mean forward current	Half wave resistive load, T _{case} = 65°C	995	А				
I _{F(RMS)}	RMS value	T _{case} = 65°C	1560	Α				
I _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	1390	Α				

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{FSM}	Surge (non-repetitive) forward current	10ma half aine; with 09/ V T = 150°C	14.0	kA
l ² t	I ² t for fusing	10ms half sine; with 0% V_{RRM} , $T_j = 150$ °C	980 x 10 ³	A ² s
I _{FSM}	Surge (non-repetitive) forward current	10me helf sine; with E09/ V T = 150°C	11.2	kA
l ² t	I ² t for fusing	10ms half sine; with 50% V _{RRM,} T _j = 150°C	627 x 10 ³	A²s

THERMAL AND MECHANICAL DATA

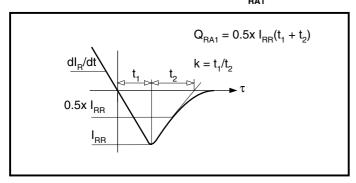
Symbol	Parameter	Conditions	Min.	Max.	Units	
$R_{th(j-c)}$	Thermal resistance - junction to case	Double side cooled	dc	-	0.018	°C/W
		Single side cooled	Anode dc	-	0.034	°C/W
			Cathode dc	-	0.038	°C/W
R _{th(c-h)}	Thermal resistance - case to heatsink	Clamping force 23.5kN with mounting compound	Double side	-	0.003	°C/W
			Single side	-	0.006	°C/W
T _{vj}	Virtual junction temperature	On-state (conducting)		-	150	°C
T _{stg}	Storage temperature range			-55	150	°C
-	Clamping force			21.0	25.0	kN



CHARACTERISTICS

Symbol	Parameter	Conditions	Тур.	Max.	Units
$V_{\scriptscriptstyle{FM}}$	Forward voltage	At 1500A peak, T _{case} = 25°C	-	1.85	V
I _{RRM}	Peak reverse current	At V _{RRM} , T _{case} = 150°C	-	100	mA
t _{rr}	Reverse recovery time		5.0	-	μs
Q _{RA1}	Recovered charge (50% chord)	$I_{\rm F} = 1000$ A, $di_{\rm RR}/dt = 100$ A/ μ s	-	800	μС
I _{RM}	Reverse recovery current	$T_{case} = 150^{\circ}C, V_{R} = 100V$	-	250	Α
К	Soft factor		1.6	-	-
V _{TO}	Threshold voltage	At T _{vj} = 150°C	-	1.1	٧
r _⊤	Slope resistance	At T _{vj} = 150°C	-	0.5	mΩ
V _{FRM}	Forward recovery voltage	di/dt = 1000A/μs, T _j = 125°C	-	-	٧

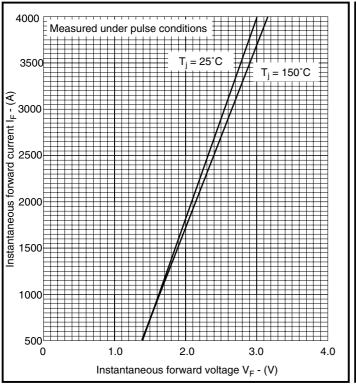
DEFINITION OF K FACTOR AND \mathbf{Q}_{RA1}



CURVES



CURVES



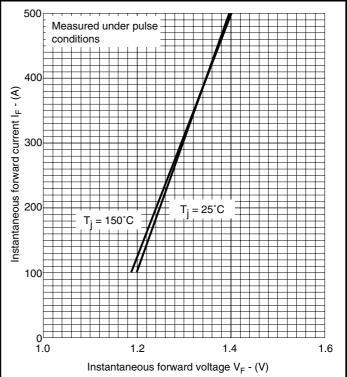


Fig.2 Maximum (limit) forward characteristics

Fig.3 Maximum (limit) forward characteristics

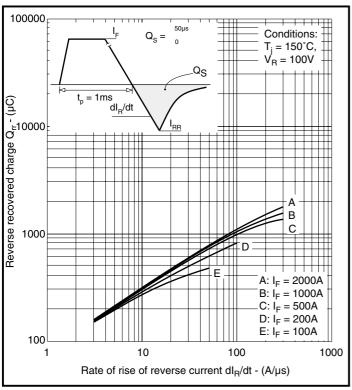


Fig.4 Recovered charge

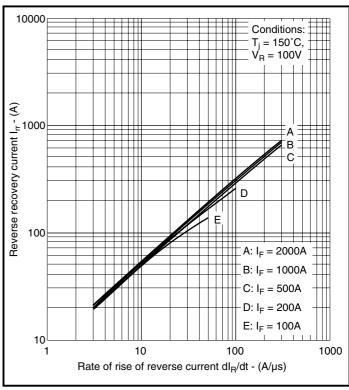


Fig.5 Typical reverse recovery current vs rate of rise of forward current



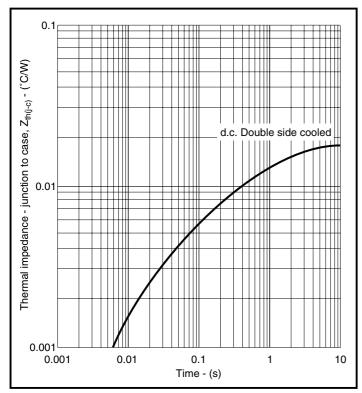
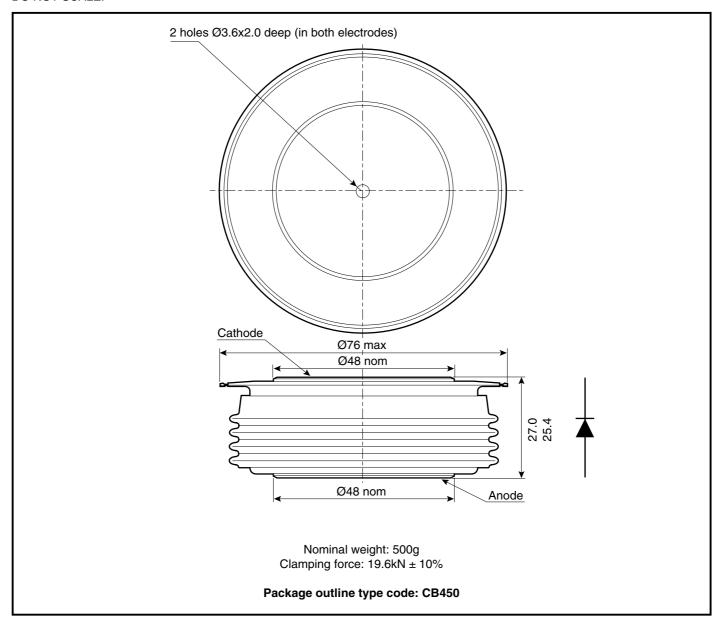


Fig.6 Maximum (limit) transient thermal impedance - junction to case - (°C/W)



PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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